# **Bluetooth Module Datasheet**

Model: SJR-BTM331

**Version: V1.1** 

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### 1 Introduction

**Sky Jiarun Technologies** introduces the pioneer of the Bluetooth 5.0 modules SJR-BTM331 which is a high performance, cost effective, low power and compact solution. The Bluetooth module provides a complete 2.4GHz Bluetooth system based on the QCC3031 BGA chipset which is a single chip radio and baseband IC for Bluetooth 2.4GHz systems. This module is fully qualified single-chip dual mode Bluetooth@v5.0 system.

### 2 Key Features

#### BTM331(QCC3031) Features

- Qualified to Bluetooth® v5.0 specification
- 120 MHz Qualcomm® Kalimba™ audio DSPs
- 32 MHz Developer Processor for applications
- Firmware Processor for system
- Flexible QSPI flash programmable platform
- Advanced audio algorithms
- High-performance 24-bit stereo audio interface
- Digital and analog microphone interfaces
- aptX, aptX HD, aptX Low Latency, SBC, and AAC audio codecs support
- Serial interfaces: UART, Bit Serializer (I<sup>2</sup> C/SPI), USB 2.0
- Integrated PMU: Dual SMPS for system/digital circuits, Integrated Li-ion battery charger

#### **Application subsystem**

- Dual core application subsystem 32 MHz operation
- 32-bit Firmware Processor:
  - Reserved for system use
  - Runs Bluetooth upper stack, profiles, house-keeping code
- 32-bit Developer Processor:Runs developer applications
- Both cores execute code from external flash memory using QSPI clocked at 32 MHz
- On-chip caches per core allow for optimized performance and power consumption

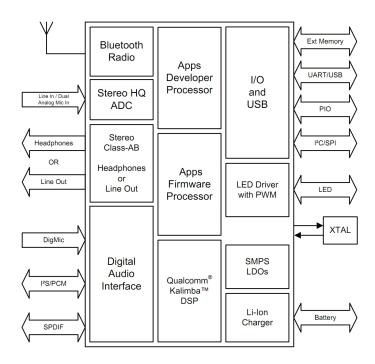
#### **Bluetooth subsystem**

- Qualified to Bluetooth v5.0 specification including 2 Mbps Bluetooth low energy (Production parts)
- Single ended antenna connection with on-chip balun and Tx/Rx switch
- Bluetooth, Bluetooth low energy, and mixed topologies supported
- Class 1 support

## **3 Applications**

Wired/wireless speakers

## **4 Block Diagram**

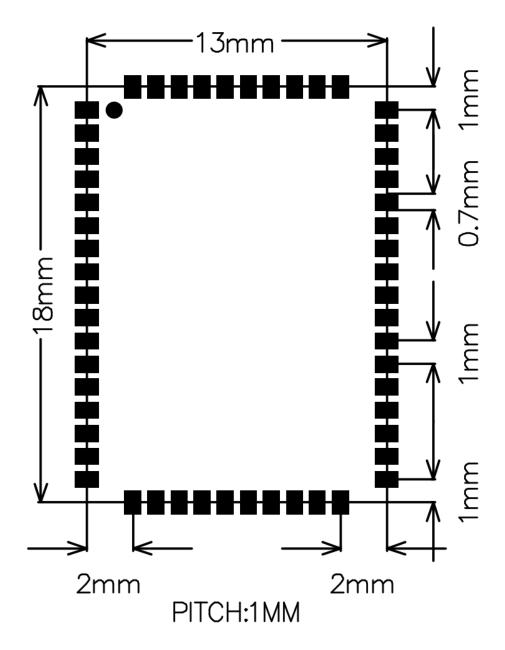


### **5 General specifications**

Model Name	SJR-BTM331
Product Description	Bluetooth 5.0 Class2 Module
Bluetooth Standard	Bluetooth 5.0
Chipset	QCC3031 QFN
Dimension	13mm x 18mm x 2.5mm
Operating Conditions	
Voltage	2.8~4.2V
Temperature	-10∼+70℃
Storage Temperature	-40∼+85℃
Electrical Specifications	
Frequency Range	2402~2480MHz
Maximum RF Transmit Power	9dBm
π /4 DQPSK Receive Sensitivity	-91dBm
8DPSK Receive Sensitivity	-81dBm

## **6 Module Package Information**

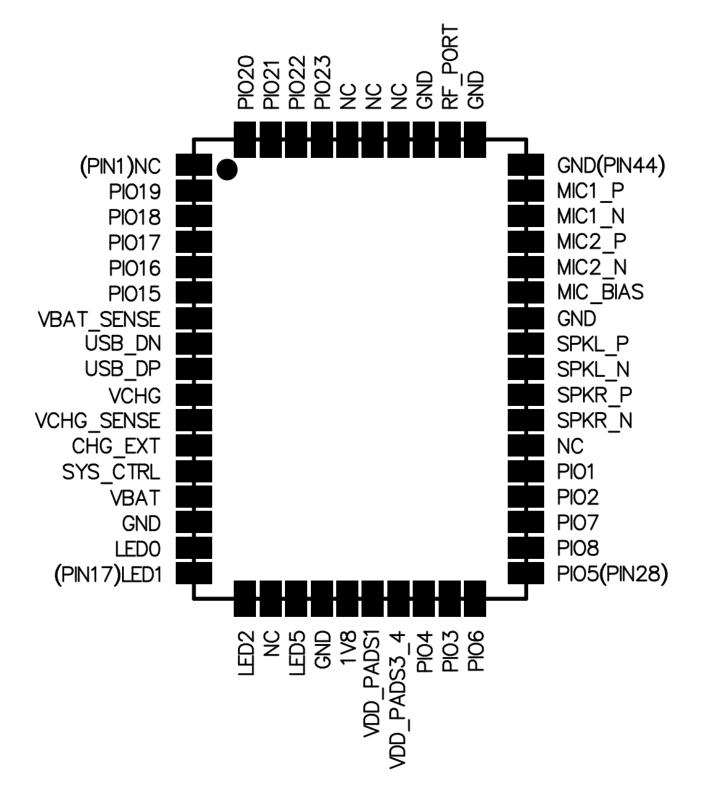
#### **6.1 Pinout Diagram and package dimensions**



Unit: MM

**Recommended PCB layout footprint** 

#### **6.2 Module Pin descriptions**



Pin#	Pin Name	Pin type	Description
1	NC	NC	NC
		Digital: Bidirectional with	Programmable I/O line 19.
2	PIO[19]	programmable strength internal	Alternative function:
		pull- up/pull-down	PCM_DIN[0]
3	PIO[18]	Digital: Bidirectional with	Programmable I/O line 18.

		programmable strength internal	Alternative function:
		pull- up/pull-down	PCM_DOUT[0]
		Digital: Bidirectional with	Programmable I/O line 17.
4	PIO[17]	programmable strength internal	Alternative function:
-	110[17]	pull- up/pull-down	PCM_SYNC
		Digital: Bidirectional with	Programmable I/O line 16.
5	PIO[16]	programmable strength internal	Alternative function:
3		pull- up/pull-down	PCM_CLK
		Digital: Bidirectional with	Programmable I/O line 15.
6	PIO[15]	programmable strength internal	Alternative function:
	F10[13]		
7	VDAT SENSE	pull- up/pull-down	MCLK_OUT
7	VBAT_SENSE	Analog	Battery voltage sense input.
8	USB_DN	Digital	USB Full Speed device D- I/O. IEC-61000-4-2
			(device level) ESD Protection
9	USB_DP	Digital	USB Full Speed device D+ I/O. IEC-61000-4-2
	_		(device level) ESD Protection
10	VCHG	Supply	Charger input to Bypass regulator.
			Charger input sense pin after external mode
			sense-resistor. High impedance.
11	VCHG_SENSE	Analog	
			NOTE If using internal charger or no charger,
			connect VCHG_SENSE direct to VCHG.
			External charger transistor current control. Connect
12	CHG_EXT	Analog	to base of external charger transistor as per
			application schematic.
			Typically connected to an ON/OFF push button.
			Boots device in response to a button press when
			power is still present from battery and/or charger but
13	SYS_CTRL	Digital input	software has placed the device in the OFF or
	0.0_0.1.12	Jighai in pat	DORMANT state. Additionally useable as a digital
			input in normal operation. No pull.
			Additional function:
			PIO[0] input only
14	VBAT	Supply	Battery voltage input.
15	GND	Ground	Ground
16	AIO[0]/LED[0]	Analog or digital input/ open drain	General-purpose analog/digital input or open drain
	, 110[0], 228[0]	output.	LED output.
17 A	AIO[1]/LED[1]	Analog or digital input/ open drain	General-purpose analog/digital input or open drain
· /	Alo[i]/EED[i]	output.	LED output.
18	AIO(2)/I ED(2)	Analog or digital input/ open drain	General-purpose analog/digital input or open drain
	AIO[2]/LED[2]	output.	LED output.
19	NC	NC	NC
20	AIO(51/I ED(5)	Analog or digital input/ open drain	General-purpose analog/digital input or open drain
	AIO[5]/LED[5]	output.	LED output.
21	GND	Ground	Ground
		1	

22	1V8	Supply	1.8V voltage output.	
23	VDD_PADS1	Supply	1.8 V/3.3 V PIO supply.	
24	VDD_PADS3_4	Supply	1.8 V/3.3 V PIO supply.	
		Digital: Bidirectional with	Programmable I/O line 4.	
25	PIO[4]	programmable strength internal	Alternative function:	
		pull- up/pull-down	TBR_MOSI[1]	
		Digital: Bidirectional with	Programmable I/O line 3.	
26	PIO[3]	programmable strength internal	Alternative function:	
		pull- up/pull-down	TBR_MISO[2]	
		Digital: Bidirectional with	Programmable I/O line 6.	
27	PIO[6]	programmable strength internal	Alternative function:	
		pull- up/pull-down	TBR_MOSI[0]	
		Digital: Bidirectional with	Programmable I/O line 5.	
28	PIO[5]	programmable strength internal	Alternative function:	
		pull- up/pull-down	TBR_MISO[1]	
		Digital: Bidirectional with	Programmable I/O line 8.	
29	PIO[8]	programmable strength internal	Alternative function:	
		pull- up/pull-down	TBR_CLK	
		Digital: Bidirectional with	Programmable I/O line 7.	
30	PIO[7]	programmable strength internal	Alternative function:	
	1.10[1]	pull- up/pull-down	TBR_MISO[0]	
		Digital: Bidirectional with	Programmable I/O line 2.	
31	PIO[2]	programmable strength internal	Alternative function:	
		pull- up/pull-down	TBR_MISO[3]	
		han abshances.	Automatically defaults to RESET# mode when the	
		Digital: Bidirectional with	device is unpowered, or in off modes.	
32	PIO[1]	programmable strength internal	Reconfigurable as a PIO after boot.	
		pull- up/pull-down	Alternative function:	
		pan appan acm	Programmable I/O line 1	
33	NC	NC	NC NC	
			Headphone/speaker differential right output,	
			negative.	
34	AUDIO_HPR_N/ SPKR_N	Analog	Alternative function:	
			Differential right line output, negative	
			Headphone/speaker differential right output,	
			positive.	
35	AUDIO_HPR_P/ SPKR_P	Analog	Alternative function:	
			Differential right line output, positive	
			Headphone/speaker differential left output,	
			negative.	
36	AUDIO_HPL_N/ SPKL_N	Analog	Alternative function:	
			Differential left line output, negative	
27	ALIDIO HDI DISDVI D	Analog	Headphone/speaker differential left output, positive.  Alternative function:	
37	AUDIO_HPL_P/ SPKL_P	Analog		
			Differential left line output, positive	

38	GND	Ground	Ground
39	AUDIO_MIC_BIAS	Analog	Mic bias output.
			Microphone differential 2 input, negative.
40	AUDIO_MIC2_N/ LINEIN_R_N	Analog	Alternative function:
			Differential audio line input right, negative
			Microphone differential 2 input, positive.
41	AUDIO_MIC2_P/ LINEIN_R_P	Analog	Alternative function:
			Differential audio line input right, positive
			Microphone differential 1 input, negative.
42	AUDIO_MIC1_N/ LINEIN_L_N	Analog	Alternative function:
			Differential audio line input left, negative
			Microphone differential 1 input, positive.
43	AUDIO_MIC1_P/ LINEIN_L_P	Analog	Alternative function:
			Differential audio line input left, positive
44	GND	Ground	Ground
45	GND	Ground	Ground
46	BT_RF	RF	Bluetooth transmit/receive.
47	GND	Ground	Ground
48	NC	NC	NC
49	NC	NC	NC
50	NC	NC	NC
		Digital: Bidirectional with	
51	PIO[23]	programmable strength internal	Programmable I/O line 23.
		pull- up/pull-down	
		Digital: Bidirectional with	
52	PIO[22]	programmable strength internal	Programmable I/O line 22.
		pull- up/pull-down	
		Digital: Bidirectional with	Programmable I/O line 21.
53	PIO[21]	programmable strength internal	Alternative function:
		pull- up/pull-down	PCM_DOUT[2]
		Digital: Bidirectional with	Programmable I/O line 20.
54	PIO[20]	programmable strength internal	Alternative function:
		pull- up/pull-down	PCM_DOUT[1]

### **7 Electrical Characteristics**

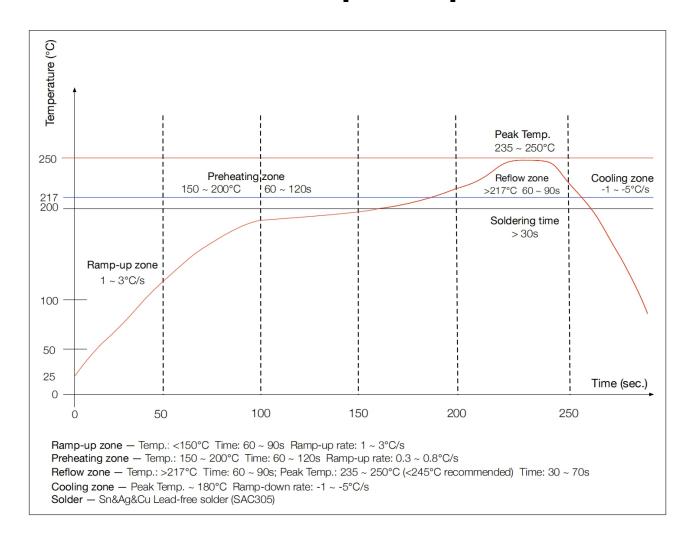
#### 7.1 Absolute Maximum Ratings

Rating	Minimum	Maximum
Storage temperature	-40°C	+85℃

### 7.2 Recommended Operating Conditions

Operating Condition	Minimum	Maximum
Operating temperature range	-10℃	+70°C
Supply voltage: VBAT	+2.8V	+4.2V

### 8 Recommended reflow temperature profile



若拆封后未立即上线,天嘉润科技建议让下次上线前务必以 125℃烘烤 9 小时以上!

### **Record of Changes**

Data	Revision	Description
2019-11-25	V1.0	Original publication of this document.
2020-04-23	V1.1	Fix PIN definition.

#### **IMPORTANT NOTICE**

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